

## **Technical Data Sheet**

MODEL NO: Q3014R4-PLK 3.0 x 1.4 x 0.8mm Red SMD

#### Features

• Compatible with automatic placement equipment

• Compatible with reflow solder process

### Applications:

Indicators

• Automotive: backlighting in dashboard and switch

Dice material	Emitted color	Lens Color
AlGaInP	Red	Water Clear

### Electrical/Optical Characteristics(Ta=25°C)

Parameter	Test	Symbol	Value			l lmit
	Condition		Min	Тур	Max	Unit
Dominant wavelength	If=30mA	λ dom	620	625	630	nm
Forward voltage	If=30mA	Vf	1.8		2.2	V
Luminous intensity	If=30mA	lv	900		1200	mcd
Viewing angle at 50% Iv	If=10mA	2 <i>\theta</i> 1/2		120		Deg
Reverse current	Vr=5V	lr			10	μА

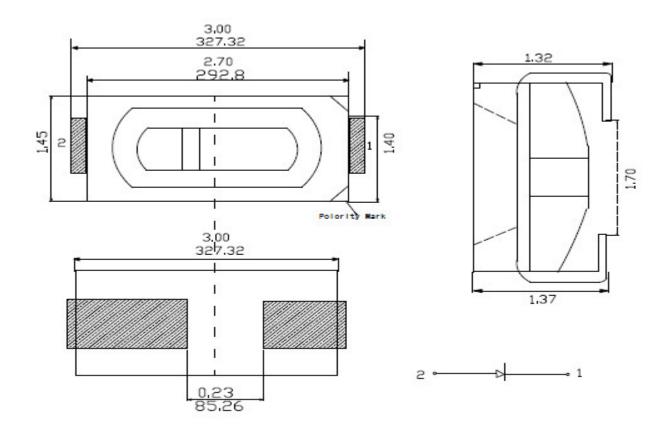
## Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Value	Unit
Power dissipation	Pd	100	mW
Forward current	lf	30	mA
Reverse voltage	Vr	5	V
Operating temperature range	Тор	-40 ~+85	$^{\circ}\!\mathbb{C}$
Storage temperature range	Tstg	-40 ~+100	$^{\circ}\!\mathbb{C}$
Peak pulsing current (1/10 duty f=1kHz)	IFP	100	mA

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# PACKAGING DIMENSIONS (mm):





# Typical Electro-Optical Characteristics Curve:

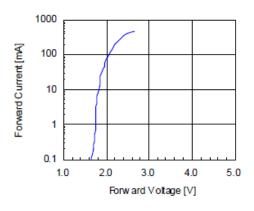


Fig 3. Forward Voltage vs. Temperature

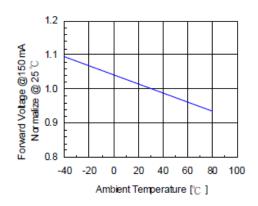


Fig 4. Relative Intensity vs. Temperature

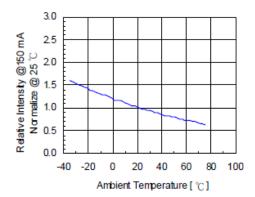
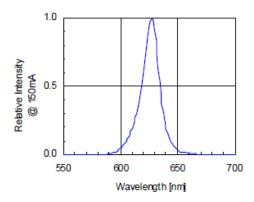


Fig 5. Relative Intensity vs. Wavelength



### **Precautions For Use:**

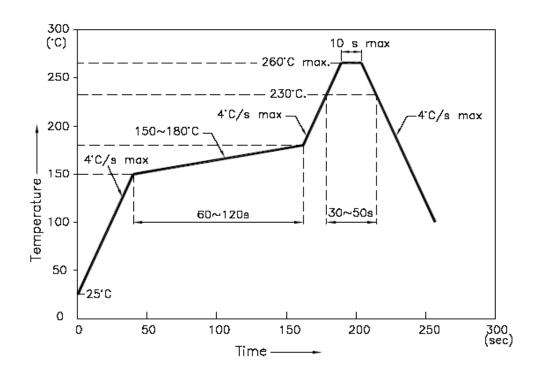
#### Over - current - proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

### Storage

- 1. The operation of temperature and R.H. are :  $5^{\circ}$ C  $\sim 30^{\circ}$ C, 60%R.H. Max.
- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).
- 3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is :  $60^{\circ}\text{C}\pm5^{\circ}\text{C}$  for 15hrs.

### ■ Reflow Temp/Time



#### NOTES:

- 1. We recommend the reflow temperature  $245^{\circ}\text{C}(\pm 5^{\circ}\text{C})$ .the maximum soldering temperature should be limited to  $260^{\circ}\text{C}$ .
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

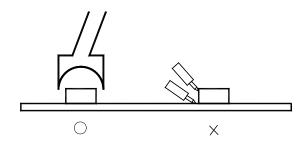


### ■Soldering iron

Basic spec is  $\leq$  5sec when 260°C. If temperature is higher, time should be shorter (+10°C  $\rightarrow$  -1sec ).Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C .

#### **■**Rework

- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow \ solder etc.